

Key Features

HTOL

- BIB for elevated temperatures
- Boards for all Burn-in systems
- Extensive design library
- Designs using all socket types
- Fine pitch layouts

HAST

- Boards for HAST and THB
- Designs for all package types
- Silicone conformal coating
- Lead free assemblies
- Boards for all chamber types

Add-ons

- Bibtest55 XL BIB test system
- Socket test probes
- Stainless steel chamber racks
- Full turn-key system solutions

BIB for all system types



Product Highlights

Overview

Abrel Products have been a market leader in the design and manufacture of burn-in boards since 1994, and are an approved global supplier to all of the major semiconductor companies. Boards can be supplied for all system types, with solutions available for many test conditions, including HTOL, PTC, HAST and 85/85.

■ Fine Pitch

Abrel manufactures boards for all the latest technologies, including fine pitch to 0.35mm and WLCSP wafer level. Abrel have an experienced engineering team with a design capability which includes layouts featuring technologies such as buried, blind, filled and capped vias, complete with laser drilling.

■ Product Overview

- High temp BIB applications to 300°C.
- HAST boards with long operating life.
- Board designs for all package types.
- Over 5000 designs completed to date.
- Large inventory of BI sockets in stock.
- Fast delivery times.
- ISO9001:2008 certified.

Burn-in & HAST Boards



Summary Product Specifications

■ Board Design

CAD systems 4x Seetrax Ranger
Schematic Ranger schematic entry
Mechanical layout Solidworks / BricsCAD
Throughput 50+ designs / month
Board types Library of all system types
Expertise >5000 BIB designs

Technology Impedance matched, stripline,

fine pitch and high power

layouts

Materials

Laminates <125°C High Tg FR4 Laminates <250°C Polyimide

Laminates <300°C High grade polyimide Solders Sn/Ag lead free

Plating Full / selective Ni and Au
Coatings Silicone conformal coat
Board supports Aluminium and stainless

Design



Assembly



■ Test



■ BIB Specification

Panel size 32" x 32" No of layers 14layers

Pitch spacing 0.3mm (WLCSP / CSP)

Trace widths 3mil spacing
Board plating Ni and Au finishes
Device pincounts >2000 pins
Maximum temperature 300°C

Maximum temperature 300°C Maximum Voltage 10KV

Technology Microvia, blind, buried, capped Socket types Enplas, Sensata, Plastronics,

Yamaichi, LIC, Aries, etc

Manufacturing

Component placement Automatic glue dot Component loading Quad pick and place Assembly SMT or thru hole Throughput 15000 placements per hour Capacity 250 boards / week **Baking** Blue M bake chamber Soldering Invicta Dual solder wave Cleaning Kerry Ultrasonic cleaning Conformal coating Silicone coating process Board test Bibtest55 XL BIB test **Product Conformance** ISO9001:2008 certified











Abrel Products

Raheen Business Park Limerick Rep of Ireland

Tel: +353 61 304566 Fax: +353 61 304567 Email: sales@abrel.com Web http://www.abrel.com